# SUP90N04-3m3P

### Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{DS} = 0 V$ , $I_{D} = 250 \mu A$	40			v	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1		2.5	v	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA	
	I <sub>DSS</sub>	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ	
Zero Gate Voltage Drain Current		$V_{DS}$ = 40 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C			50		
		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ}\text{C}$			250		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10$ V, $V_{GS} = 10$ V	50			Α	
	D	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 22 A		0.0027	0.0033	Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.0034	0.0041		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 20 A		169		S	
Dynamic <sup>b</sup>	•		•	•			
Input Capacitance	C <sub>iss</sub>			5286		pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V, V_{DS} = 20 V, f = 1 MHz$		705			
Reverse Transfer Capacitance	C <sub>rss</sub>			283			
Total Gate Charge <sup>c</sup>	Qg			87	131	nC	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		15.3			
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			12.2			
Gate Resistance	Rg	f = 1 MHz	0.5	2.7	5.4	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			11	20		
Rise Time <sup>c</sup>	t <sub>r</sub>			7	14	-	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>		45	68	ns		
Fall Time <sup>c</sup>	t <sub>f</sub>			7	14		
Drain-Source Body Diode Ratings an	nd Characteris	stics T <sub>C</sub> = 25 °C <sup>b</sup>					
Continuous Current	ا <sub>S</sub>				90	_	
Pulsed Current	I <sub>SM</sub>				160	A	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_{F} = 10 \text{ A}, V_{GS} = 0 \text{ V}$		0.72	1.2	V	
Reverse Recovery Time	t <sub>rr</sub>			42	63	ns	
Peak Reverse Recovery Current	I <sub>RM(REC)</sub>	I <sub>F</sub> = 10 A, dl/dt = 100 A/μs		2.5	3.8	Α	
Reverse Recovery Charge	Q <sub>rr</sub>			52	78	nC	

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

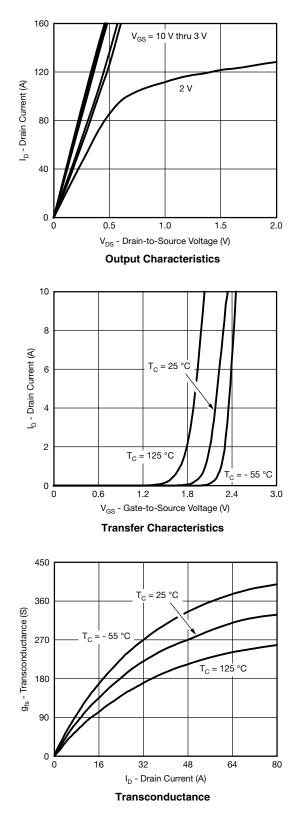
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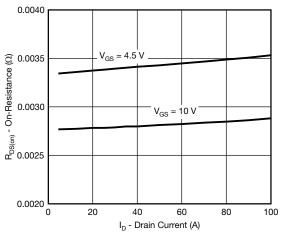


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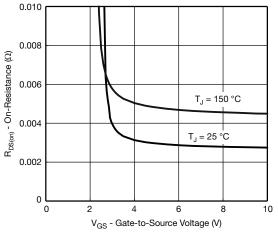
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

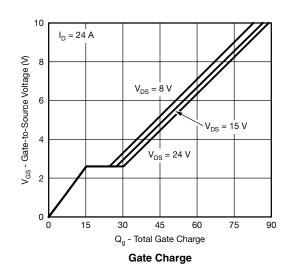




**On-Resistance vs. Drain Current** 





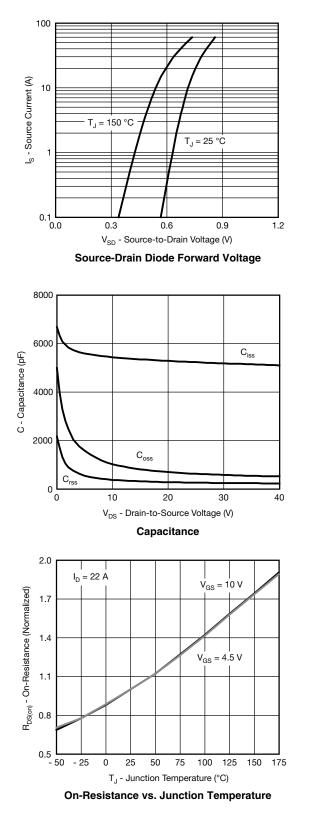


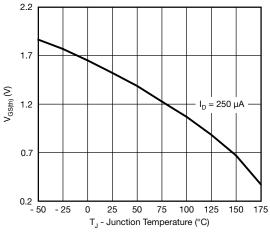
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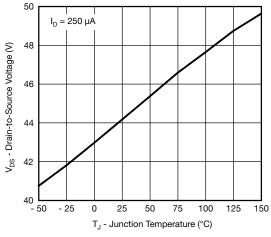
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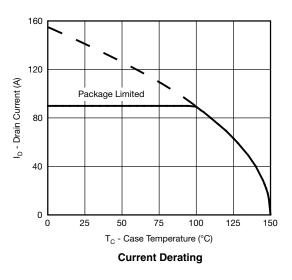




Threshold Voltage



Drain Source Breakdown vs. Junction Temperature



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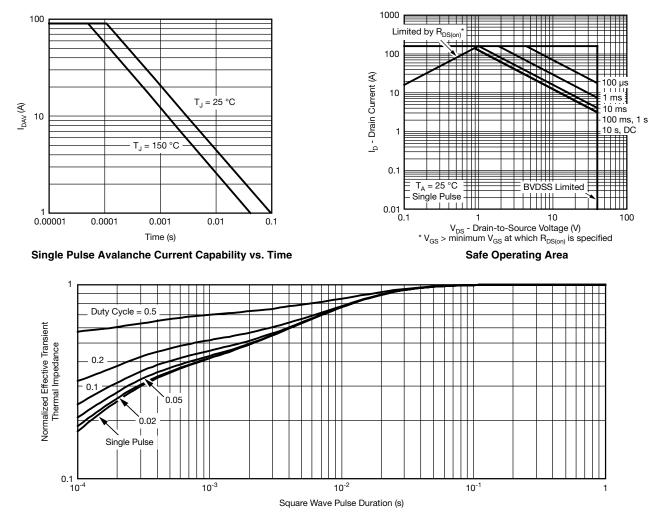
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Normalized Thermal Transient Impedance, Junction-to-Case

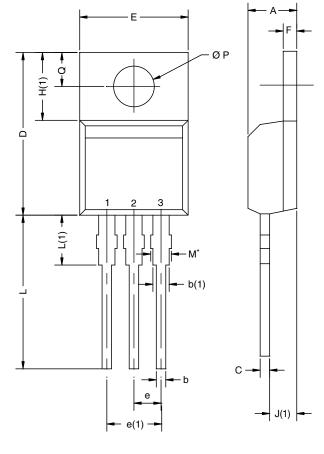
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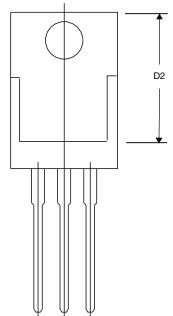
# **TO-220AB**



	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
D2	12.19	12.70	0.480	0.500	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: T14- DWG: 547	0413-Rev. P, 1	16-Jun-14			

Note

 $^{\star}$  M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



Revison: 16-Jun-14

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